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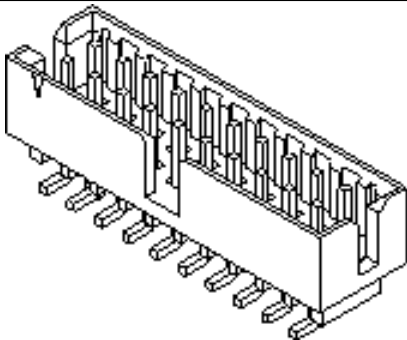
Part Number: [0878321020](#)
Status: **Active**
Overview:
Description: 2.00mm (.079") Pitch Milli-Grid™ Header, Surface Mount, Vertical, Shrouded, Lead-free, 10 Circuits, 0.38µm (15µ") Gold (Au) Plating, without Locking Window, with Centre Polarization Slot, PCB Locator, Tube

Documents:
[3D Model](#) [Product Specification PS-87831-027 \(PDF\)](#)
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

General
Product Family PCB Headers
Series [87832](#)
Application Wire-to-Board
Comments Contact Molex for application in automotive industry
Overview Milli-Grid®#153;
Product Name Milli-Grid™

Physical
Breakaway No
Circuits (Loaded) 10
Circuits (maximum) 10
Color - Resin Black
First Mate / Last Break No
Flammability 94V-0
Glow-Wire Compliant No
Guide to Mating Part No
Keying to Mating Part Yes
Lock to Mating Part No
Material - Metal Phosphor Bronze
Material - Plating Mating Gold
Material - Plating Termination Tin
Material - Resin Nylon
Number of Rows 2
Orientation Vertical
PCB Locator Yes
PCB Retention None
Packaging Type Tube
Pitch - Mating Interface (in) 0.079 In
Pitch - Mating Interface (mm) 2.00 mm
Pitch - Term. Interface (in) 0.079 In
Pitch - Term. Interface (mm) 2.00 mm
Plating min: Mating (µin) 15
Plating min: Mating (µm) 0.38
Plating min: Termination (µin) 75
Plating min: Termination (µm) 1.88
Polarized to Mating Part Side Slots (2)
Polarized to PCB No
Shrouded Fully
Stackable No
Temperature Range - Operating -55°C to +105°C
Termination Interface: Style Surface Mount

Electrical
CSA LR19980
Current - Maximum 2A



Series image - Reference only

EU RoHS
ELV and RoHS
Compliant
REACH SVHC
Contains SVHC: No
Halogen-Free
Status
Not Reviewed



Need more information on product environmental compliance?

Email productcompliance@molex.com
Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series
[87832 Series](#)

Mates With
[50394](#) Wire-to-Board Terminals. [51110](#) Wire-to-Board Crimp Housing. [87568](#) Wire-to-Board IDT Housings. [79107](#) Board-to-Board Top Entry Through Hole Receptacle. [79108](#) Board-to-Board FFC/FPC Top Entry Through Hole Receptacle. L

UL	E29179
Voltage - Maximum	125V

Solder Process Data

Duration at Max. Process Temperature (seconds)	10
Lead-free Process Capability	Reflow Capable (SMT only)
Max. Cycles at Max. Process Temperature	1
Process Temperature max. C	260

Material Info

Reference - Drawing Numbers

Product Specification	PS-87831-027
Sales Drawing	SD-87832-006

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